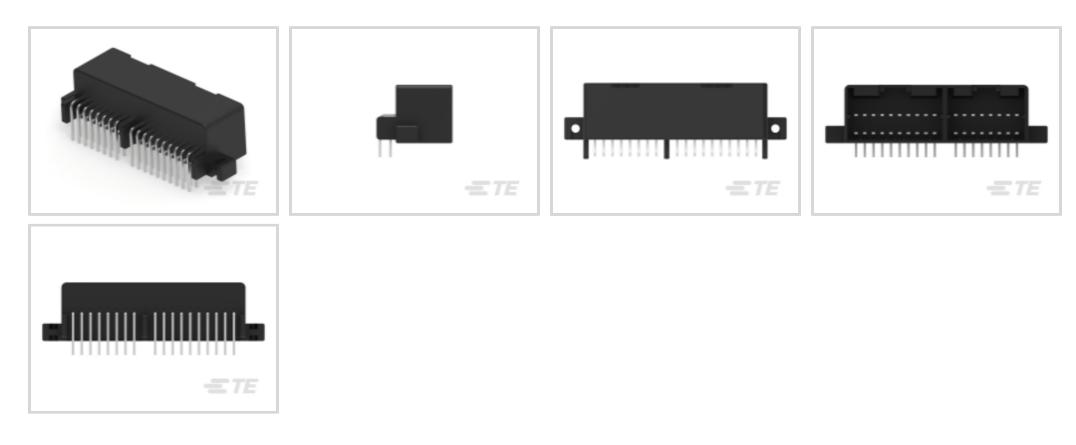
# 174146-2 - ACTIVE

#### Multilock Connector System

TE Internal #: 174146-2 PCB Mount Header, Horizontal, Wire-to-Board, 36 Position, .098 in [2.5 mm] Centerline, Fully Shrouded, Tin (Sn), Multilock Connector System

#### View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > SIGNAL HEADER



Connector System: Wire-to-Board Number of Positions: 36 Centerline (Pitch): 2.5 mm [.098 in] Sealable: No

PCB Mount Orientation: Horizontal

#### All SIGNAL HEADER (412)

Connectivity

#### Features

#### **Product Type Features**

Hybrid Header	No	
Connector & Housing Shape	Rectangular	
PCB Connector Assembly Type	PCB Mount Header	
Header Type	Fully Shrouded	
Connector System	Wire-to-Board	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Sections	2	
Number of Signal Positions	36	
Number of Positions	36	
PCB Mount Orientation	Horizontal	
Number of Rows	2	

**S** For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 36 Position, .098 in [2.5 mm] Centerline, Fully Shrouded, Tin (Sn), Multilock Connector System



#### **Electrical Characteristics**

Iominal Voltage Architecture 12 Operating Voltage 12 dy Features 12 rimary Product Color Bl: Intact Features 11 Contact Size 11 Contact Size 11 Contact Type 13 Contact Type 14 Contact Type 14 Contact Mating Tab Width 11 Contact Mating Area Plating Material 16 Contact Mating Area Plating Material 16	mm[.039 in]	
Operating Voltage 12   dy Features 12   rimary Product Color Blantact Features   ntact Features 1   contact Size 1   contact Type Ta   Nating Tab Width 1   Nating Tab Thickness 64   contact Mating Area Plating Material Time   rimination Features 1	2 VDC ack nm ab mm[.039 in]	
dy Features rimary Product Color Bla ntact Features Contact Size In Contact Type Ta Nating Tab Width 1 r Nating Tab Thickness 64 Contact Mating Area Plating Material Tim rmination Features	ack nm ab mm[.039 in]	
rimary Product Color Blantact Features Intact Features Intact Features Intact Size Intact Size Intact Size Intact Type Tactor Type Tactor Type Intervention Tactor Type Intervention Sector Contact Mating Area Plating Material Intervention Features	nm ab mm[.039 in]	
Intact Features       1         Contact Size       1         Contact Type       Ta         Contact Type       1         Aating Tab Width       1         Mating Tab Thickness       .64         Contact Mating Area Plating Material       Tip         Imination Features       Imination Features	nm ab mm[.039 in]	
Contact Size1Contact TypeTaMating Tab Width1Mating Tab Thickness.64Contact Mating Area Plating MaterialTimeImmination FeaturesImmination Features	ab mm[.039 in]	
Contact Type Ta   Mating Tab Width 1 m   Mating Tab Thickness .64   Contact Mating Area Plating Material Time   rmination Features	ab mm[.039 in]	
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Mating Tab Thickness       .64         Contact Mating Area Plating Material       Time         Immination Features       Time		
Contact Mating Area Plating Material Tir rmination Features	4 mm[ 025 in]	
rmination Features	.64 mm[.025 in]	
	Tin (Sn)	
ermination Method to Printed Circuit Board Th		
	nrough Hole - Solder	
echanical Attachment		
Iounting Holes W	ſith	
lating Retention W	With	
1ating Alignment W	With	
CB Mount Alignment W	Without	
anel Mount Feature W	Without	
CB Mount Retention W	Without	
CB Mount Retention Type Mo	Mounting Hole	
lating Retention Type Lo	ocking Interface	
using Features		
Centerline (Pitch) 2.5	5 mm[.098 in]	
nensions		
Connector Length 21	.7 mm[.854 in]	
Connector Width 63		
CB Thickness (Recommended) 1.6	3.5 mm[2.5 in]	
rofile Height from PCB 16	3.5 mm[2.5 in] 6 mm[.063 in]	
age Conditions		

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PCB Mount Header, Horizontal, Wire-to-Board, 36 Position, .098 in [2.5 mm] Centerline, Fully Shrouded, Tin (Sn), Multilock Connector System



Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100 °C, 105 °C[149 °F][158 °F][167 °F][176 °F] [185 °F][194 °F][212 °F][221 °F]	
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]	
Operation/Application		
Shielded	No	
Circuit Application	Signal	
Industry Standards		
UL Flammability Rating	UL 94HB	
Packaging Features		
Packaging Type	Tube	
Packaging Quantity	35	
Other		
Interface Number	174047	
Product Compliance		
For compliance documentation, visit the product page on TE.com>		

EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2022 (223) Candidate List Declared Against: JAN 2022 (223) Does not contain REACH SVHC	
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free	
Solder Process Capability	Wave solder capable to 240°C	

Compliant

#### Product Compliance Disclaimer

EU RoHS Directive 2011/65/EU

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

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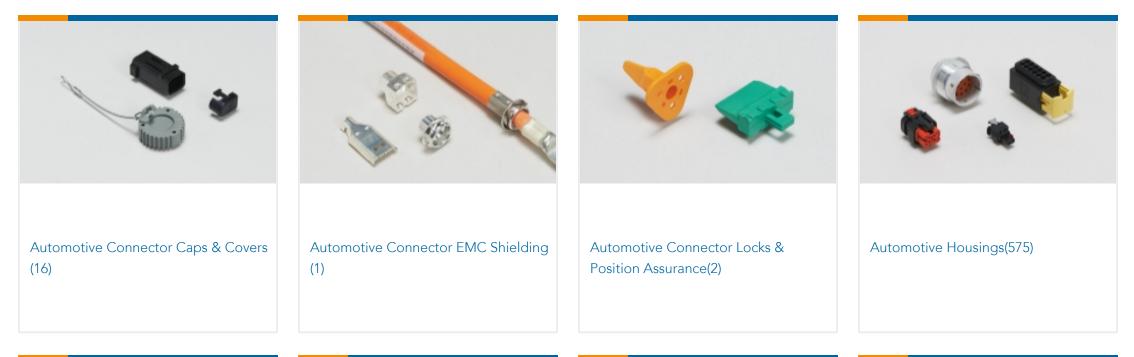


on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

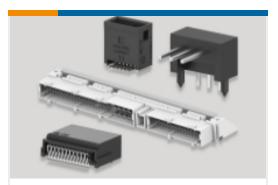
### **Compatible Parts**



## Also in the Series | Multilock Connector System



	AND		
Automotive Seals & Cavity Plugs(2)	Automotive Terminals(141)	Insertion & Extraction Tools(6)	Other Automotive Connector Accessories(9)



PCB Headers & Receptacles(129)

Customers Also Bought

PCB Mount Header, Horizontal, Wire-to-Board, 36 Position, .098 in [2.5 mm] Centerline, Fully Shrouded, Tin (Sn), Multilock Connector System





### Documents

**CAD** Files

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_174146-2\_H.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_174146-2\_H.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_174146-2\_H.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

Japanese

**Product Specification** 

Japanese

Instruction Sheets

Instruction Sheet (non U.S.)

English

040 SERIES MULTI-LOCK CONNECTOR

English